

# LCD Module Specification

Model No.: LG128643-SMDWH6V  
LG128643-SFDWH6V  
LG128643-BMDWH6V  
LG128643-LMDWH6V  
LG128643-FMDWH6V  
LG128643-FFDWH6V  
LG128643-QFDWH6V

## Table of Contents

1. BASIC SPECIFICATIONS .....	2
2. ABSOLUTE MAXIMUM RATINGS .....	3
3. ELECTRICAL CHARACTERISTICS .....	4
4. OPERATING PRINCIPLES & METHODS .....	7
5. DISPLAY CONTROL INSTRUCTIONS .....	10
6. DISPLAY DATA RAM ADDRESS MAP .....	13
7. CONNECTION WITH 8051 FAMILY MPU .....	14
8. ELECTRO-OPTICAL CHARACTERISTICS .....	15
9. DIMENSIONAL OUTLINE .....	16
10. LCD MODULE NUMBERING SYSTEM .....	17
11. PRECAUTIONS FOR USE OF LCD MODULE .....	18

## RECORD OF REVISION

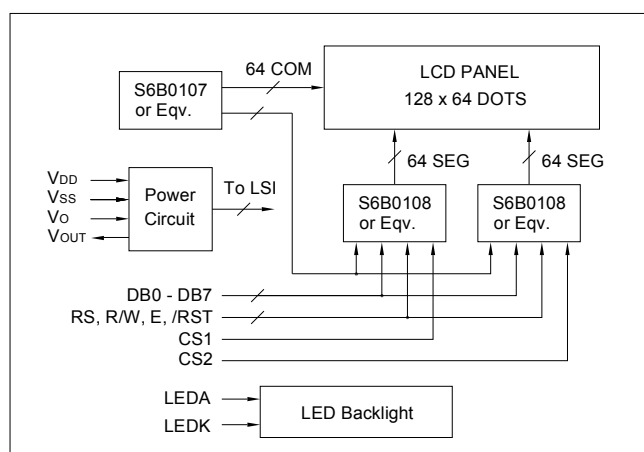
Rev.	Date	Page	Item	Description
0.1	2007/11/01	--	--	New release
0.2	2010/03/25	2	1.1	Add QFDWH6V mode
0.3	2010/10/18	2	1.1	Add SMDWH6V mode

# 1. BASIC SPECIFICATIONS

## 1.1 Features

Item		Specifications	Unit
Display Format		128 x 64	dot
LCD Type	SMDWH6V	STN - Yellow Green - Positive - Transmissive Dark blue characters on yellow green background	-
	SFDWH6V	STN - Yellow Green - Positive - Transflective Dark blue characters on yellow green background	-
	BMDWH6V	STN - Blue - Negative - Transmissive White characters on blue background	-
	LMDWH6V	FSTN - Blue - Negative - Transmissive Pure white characters on blue background	-
	FMDWH6V	FSTN - Positive - Transmissive Black characters on white background	-
	FFDWH6V	FSTN - Positive - Transflective Black characters on white background	-
	QFDWH6V	FFSTN - Negative - Transflective White characters on black background	-
Driving Method		1/64 Duty, 1/9 Bias	-
Viewing Direction		6	O'clock
Backlight & Color		LED, white color	-
Outline Dimension (WxHxT)		93.0 x 70.0 x 13.5	mm
Viewing Area (WxH)		72.0 x 39.0	mm
Active Area (WxH)		66.52 x 33.24	mm
Dot Pitch (WxH)		0.52 x 0.52	mm
Dot Size (WxH)		0.48 x 0.48	mm
Weight		75	g
Controller		S6B0108	-
Interface		8-bit parallel (6800 series MPU)	-
Power Supply (VDD)		5.0 (Built-in voltage converter for LCD driving)	V

## 1.2 Block Diagram



### 1.3 Terminal Functions

Pin No.	Symbol	Level	Function
1	VSS	0V	Ground
2	VDD	+5V	Power supply for logic
3	VO	-	Operating voltage for LCD (contrast adjusting) Refer to section 3.5
4	RS	H/L	Data or instruction selection H: Display data    L: Instruction code
5	R/W	H/L	Read or write selection H: Read operation    L: Write operation
6	E	H, H→L	Enable signal. In read mode (R/W="H"), data appears at DB0 to DB7 while E is "H". In write mode (R/W="L"), data of DB0 to DB7 is latched at the falling edge of E.
7	DB0	H/L	Data bus
8	DB1	H/L	
9	DB2	H/L	
10	DB3	H/L	
11	DB4	H/L	
12	DB5	H/L	
13	DB6	H/L	
14	DB7	H/L	
15	CS1	H	Chip selection for IC1 (left half panel). Active "H".
16	CS2	H	Chip selection for IC2 (right half panel). Active "H".
17	/RST	L	Reset signal. Active "L".
18	VO <sub>UT</sub>	-10V	Output voltage for LCD driving
19	LEDA	+5V	Power supply for LED backlight Refer to section 3.3 to 3.4
20	LEDK	0V	

## 2. ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min.	Max.	Unit
Supply Voltage (Logic)	VDD-VSS	-0.3	7.0	V
Supply Voltage (LCD)	VDD-VO	-0.3	19.0	V
Input Voltage	V <sub>I</sub>	-0.3	VDD+0.3	V
Operating Temperature	T <sub>opr</sub>	-20	70	°C
Storage Temperature	T <sub>stg</sub>	-30	80	°C

### 3. ELECTRICAL CHARACTERISTICS

#### 3.1 DC Characteristics

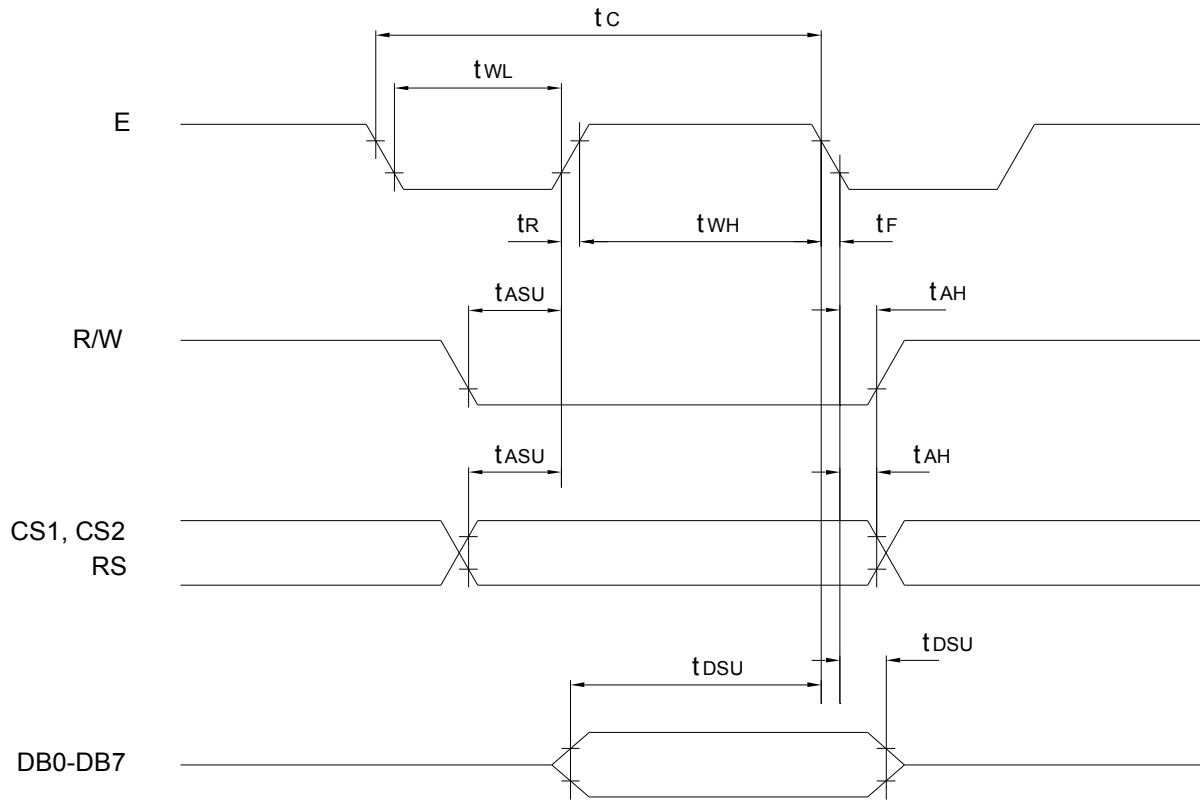
(VDD=5.0V±10%, Ta=25°C)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage (Logic)	VDD		4.5	5.0	5.5	V
Supply Voltage (LCD Drive)	VDD-VO		--	11.7	--	V
Input High Voltage	VIH		2.0	--	VDD	V
Input Low Voltage	VIL		0	--	0.8	V
Output High Voltage	VOH	IOH=-0.2mA	2.4	--	VDD	V
Output Low Voltage	VOL	IOL=1.6mA	0	--	0.4	V
Supply Current (Logic)	IDD	VDD=5.0V	--	6.0	8.0	mA

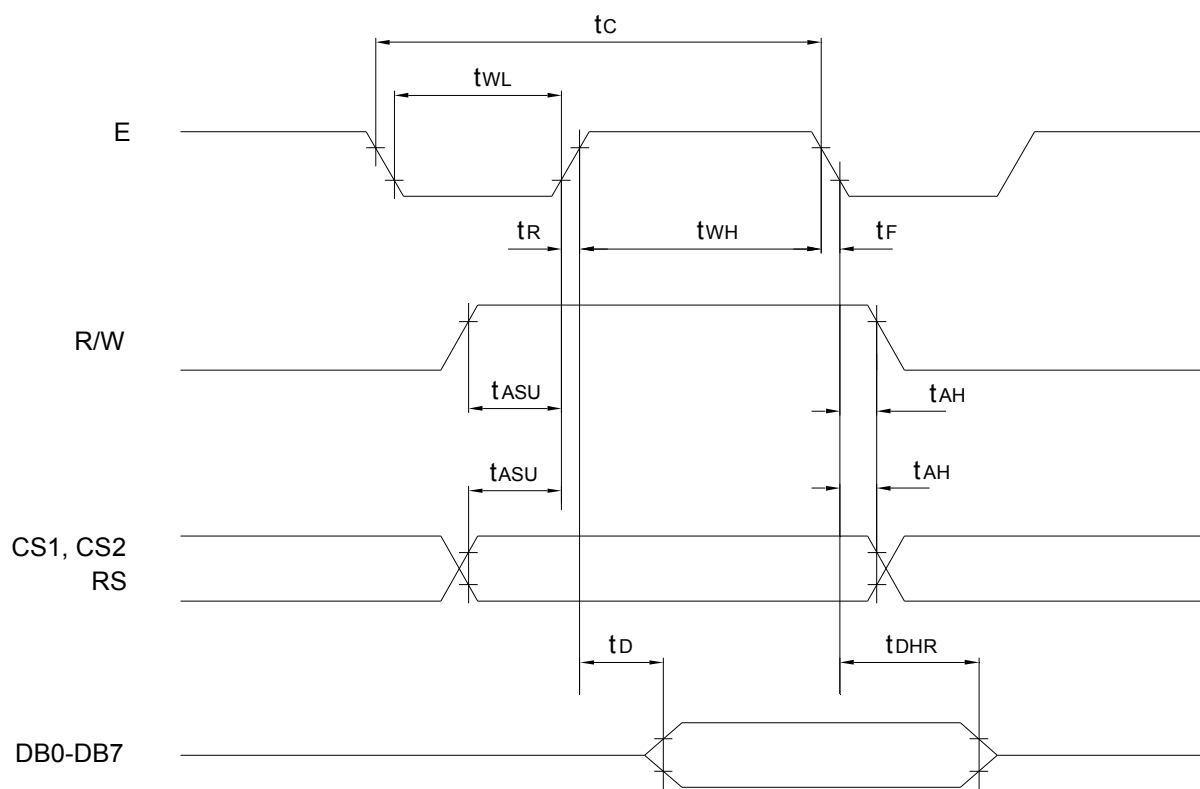
#### 3.2 Interface Timing Chart

(VDD=5.0V±10%, Ta=25°C)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
E Cycle	t <sub>C</sub>	1000	--	--	ns
E High Level Width	t <sub>WH</sub>	450	--	--	ns
E Low Level Width	t <sub>WL</sub>	450	--	--	ns
E Rise Time	t <sub>R</sub>	--	--	25	ns
E Fall Time	t <sub>F</sub>	--	--	25	ns
Address Set-Up Time	t <sub>ASU</sub>	140	--	--	ns
Address Hold Time	t <sub>AH</sub>	10	--	--	ns
Data Set-Up Time	t <sub>DSU</sub>	200	--	--	ns
Data Delay Time	t <sub>D</sub>	--	--	320	ns
Data Hold Time(Write)	t <sub>DHW</sub>	10	--	--	ns
Data Hold Time(Read)	t <sub>DHR</sub>	10	--	--	ns



MPU Write Timing

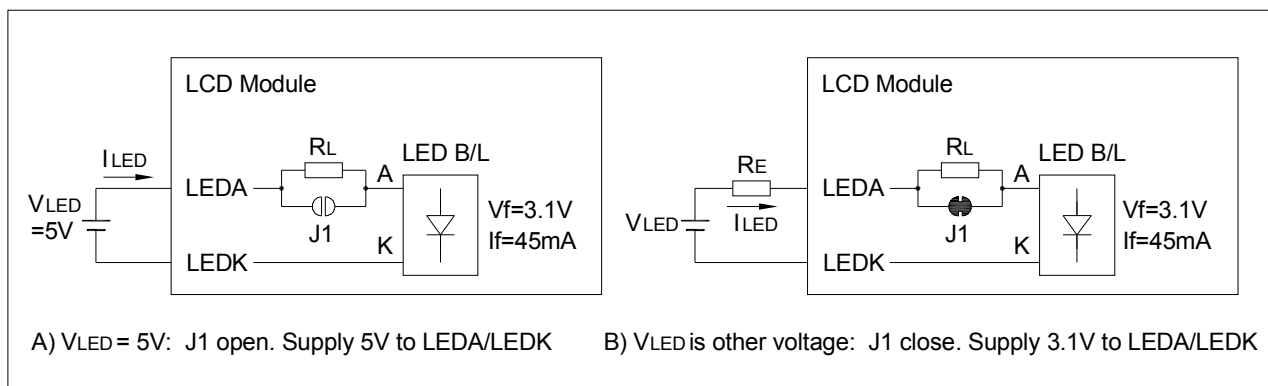


MPU Read Timing

### 3.3 LED Backlight Characteristics (Ta=25°C)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	Vf		2.9	3.1	3.3	V
Forward Current	If	Vf=3.1V	--	45	--	mA
Color	White					

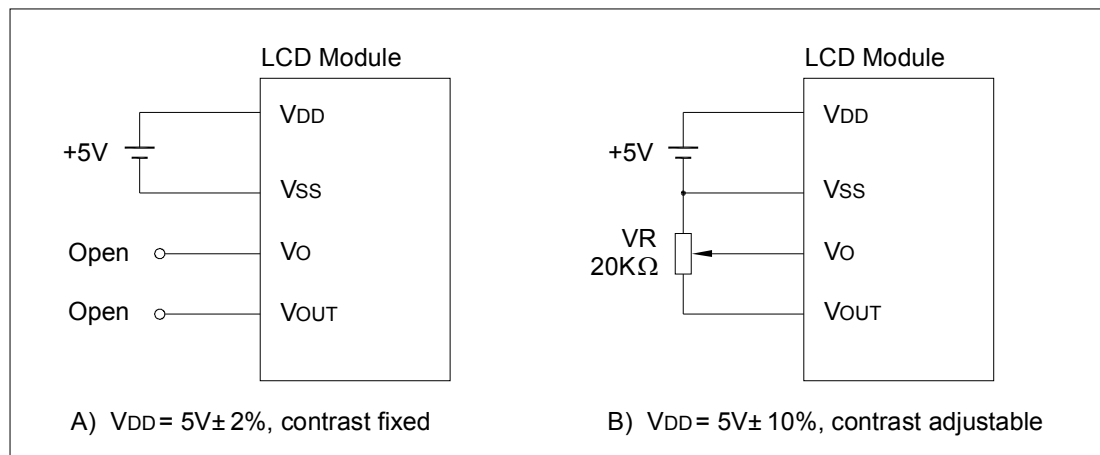
### 3.4 Power Supply for LED Backlight



\*  $R_L$  (internal) and  $R_E$  (external) are the current limiting resistors for LED backlight

- 1)  $V_{LED}=5.0V$ : J1 open. Supply 5.0V to LEDA (Pin 19) and LEDK (Pin 20) **<Default>**
- 2)  $V_{LED}=3.3V$ : J1 close;  $R_E=(3.3V-3.1V)/45mA=4.5\Omega$ . Supply 3.1V to LEDA (Pin 19) and LEDK (Pin 20)
- 3)  $V_{LED}$  is other voltage: J1 close;  $R_E=(V_{LED}-3.1V)/45mA$ . Supply 3.1V to LEDA (Pin 19) and LEDK (Pin 20)

### 3.5 Power Supply for Logic and LCD Driving



\*  $V_O$  is LCD driving voltage (contrast adjusting). Adjust  $V_{DD}-V_O$  voltage to be around 11.7V for a better contrast.

## 4. OPERATING PRINCIPLES & METHODS

### 4.1 I/O Buffer

Input buffer controls the status between the enable and display of chip. Unless the IC (selected by CS1 or CS2) is in active mode, input or output of data and instruction does not execute. Therefore internal state is maintained. But /RST can operate regardless the level of CS1 or CS2.

### 4.2 Register

Both input register and output register are provided to interface to MPU of which the speed is different from that of internal operation. The selections of these registers depend on the combination of R/W and RS signals.

RS	R/W	Function
L	L	Instruction
	H	Status read (busy check)
H	L	Data write (from input register to display data RAM)
	H	Data read (from display data RAM to output register)

#### 4.2.1 Input Register

Input register stores the data temporarily before writing it into display data RAM.

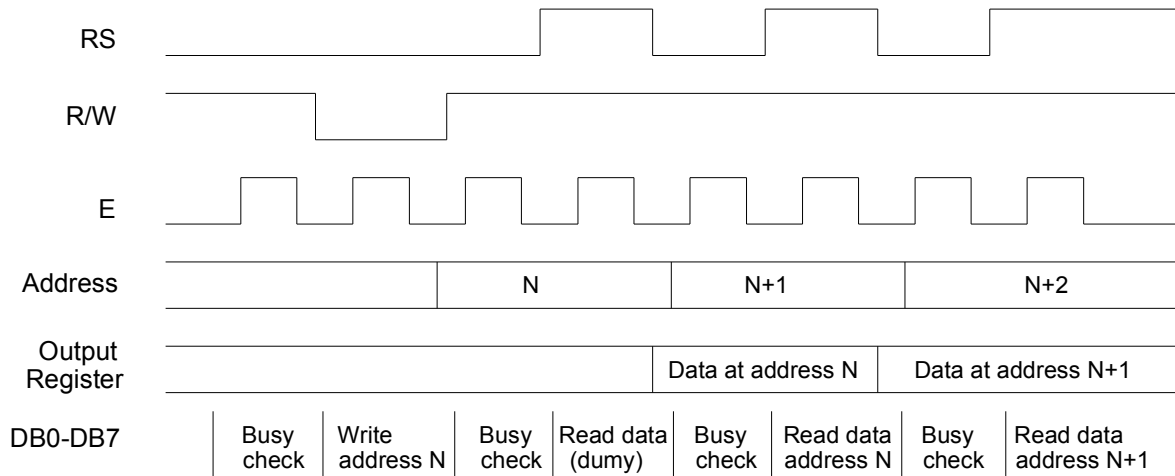
When the IC is in active mode, R/W and RS select the input register. The data from MPU is written into input register, then into display data RAM. Data is latched at falling edge of the E signal and then written into the display data RAM automatically by internal operation.

#### 4.2.2 Output Register

Output register stores the data temporarily which is read from display data RAM when the IC is in active mode and R/W and RS=H, stored data in display data RAM is latched in output register. When the IC is in active mode and R/W=H, RS=L, status data (busy check) can be read out.

To read the contents of display data RAM, twice access of read instruction is needed. In first access, data in display data RAM is latched into output register. In second access, MPU can read data that is latched in output register. That is, to read the data in display data RAM, it needs dummy read. But status read does not need dummy read.

The following shows the MPU read timing.



### MPU Read Timing

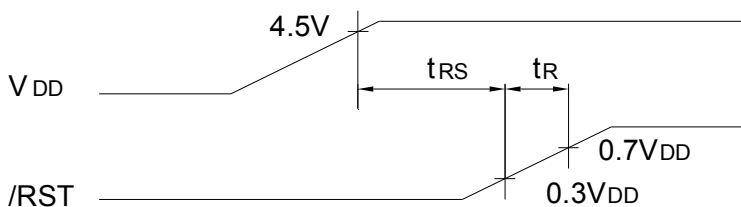
#### 4.3 Reset

The system can be initialized by setting /RST terminal at low level when turning power on. When /RST becomes low, following procedure is occurred.

1. Display off
2. Display start line register is set by 0. (Z address 0)

While /RST is low level, no instruction except status read can be accepted. Reset status appears at DB4 of status byte, after DB4 becomes "L", any instruction can be accepted. The conditions of power supply at initial power up are shown below.

Item	Symbol	Min.	Typ.	Max.	Unit
Reset time	$t_{RS}$	1.0	--	--	$\mu s$
Rise time	$t_R$	--	--	200	ns



#### 4.4 Busy Flag

Busy flag indicates the system is now internally operating or not. When busy flag is "H", the system is in internal operation. When busy flag is "L", the system can accept data or instruction. Busy flag is read out on DB7 by the Status Read instruction.



#### 4.5 Display On/Off Flip-Flop

The display on/off flip-flop makes on/off the liquid crystal display. When flip-flop is reset (logical low), selective voltage or non selective voltage appears on segment output terminals. When flip-flop is set (logical high), non selective voltage appears on segment output terminals regardless of display RAM data.

The display on/off flip-flop can change status by instruction. The display data at all segments disappear while /RST is low. The status of the flip-flop is output on DB5 by Status Read instruction.

#### 4.6 X Page Register

X page register designates page of the internal display data RAM. Count function is not available. The address is set by instruction.

#### 4.7 Y Address Counter

Y address counter designates address of the internal display data RAM. The address is set by instruction and is increased by 1 automatically by read or write operations of display data.

#### 4.8 Display Data RAM

Display data RAM stores a display data for liquid crystal display. 1 bit data of this RAM corresponds to light ON (data=1) or light OFF (data=0) of 1 dot on the display panel.

#### 4.9 Display Start Line Register

The register specifies a line in display data RAM that corresponds to the top line of LCD panel, when displaying contents in display data RAM on the LCD panel. Bit data (DB<0:5>) of the display start line information is written into this register by display start line set instruction. It is used for scrolling of the liquid crystal display screen.

## 5. DISPLAY CONTROL INSTRUCTIONS

The display control instructions control the internal state of the S6B0108. Instruction is received from MPU to S6B0108 for the display control. The following table shows various instructions.

Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Display ON/OFF	0	0	0	0	1	1	1	1	1	0/1	Control the display on or off. Internal status and display RAM data are not affected.
Set Address (Y address)	0	0	0	1	Y address (0-63)						Set the Y address at the Y address counter.
Set Page (X address)	0	0	1	0	1	1	1	Page (0-7)			Set the X address at the X address register.
Display Start Line (Z address)	0	0	1	1	Display start line (0-63)						Indicate the display data RAM displayed at the top of the screen.
Status Read	0	1	B U S Y	0	O N / O F F	R E S E T	0	0	0	0	Read status. BUSY    0: Ready 1: In internal operation ON/OFF 0: Display ON 1: Display OFF RESET   0: Normal 1: Reset
Write Display Data	1	0	Display Data								Write data (DB0-DB7) into display data RAM. After writing instruction, Y address is increased by 1 automatically.
Read Display Data	1	1	Display Data								Read data (DB0-DB7) from display data RAM to the data bus.

### 5.1 Display On/Off

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	1	1	1	1	1	D

The display data appears when D is 1 and disappears when D is 0.

Though the data is not on the screen with D=0, it remains in the display data RAM.

Therefore, you can make it appear by changing D=0 into D=1.

### 5.2 Set Address (Y Address)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0

Y address (AC0-AC5) of the display data RAM is set in the Y address counter.

The address is set by instruction and increased by 1 automatically by read or write operations of display data.

### 5.3 Set Page (X Address)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	0	1	1	1	AC2	AC1	AC0

X address (AC0-AC2) of the display data RAM is set in the X address register.

Writing or reading to or from MPU is executed in this specified page until the next page is set.

### 5.4 Display Start Line (Z Address)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	1	AC5	AC4	AC3	AC2	AC1	AC0

Z address (AC0-AC5) of the display data RAM is set in the display start line register and displayed at the top of the screen.

## 5.5 Status Read

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	1	BUSY	0	ON/OFF	RESET	0	0	0	0

- BUSY**

When BUSY is 1, the chip is executing internal operation and no instructions are accepted.

When BUSY is 0, the chip is ready to accept any instructions.

- ON/OFF**

When ON/OFF is 1, the display is off.

When ON/OFF is 0, the display is on.

- RESET**

When RESET is 1, the system is being initialized.

In this condition, no instructions except status read can be accepted.

When RESET is 0, initializing has finished and the system is in the normal operation condition.

## 5.6 Write Display Data

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	0	D7	D6	D5	D4	D3	D2	D1	D0

Write data (D0-D7) into the display data RAM.

After writing instruction, Y address is increased by 1 automatically.

## 5.7 Read Display Data

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	1	D7	D6	D5	D4	D3	D2	D1	D0

Read data (D0-D7) from the display data RAM.

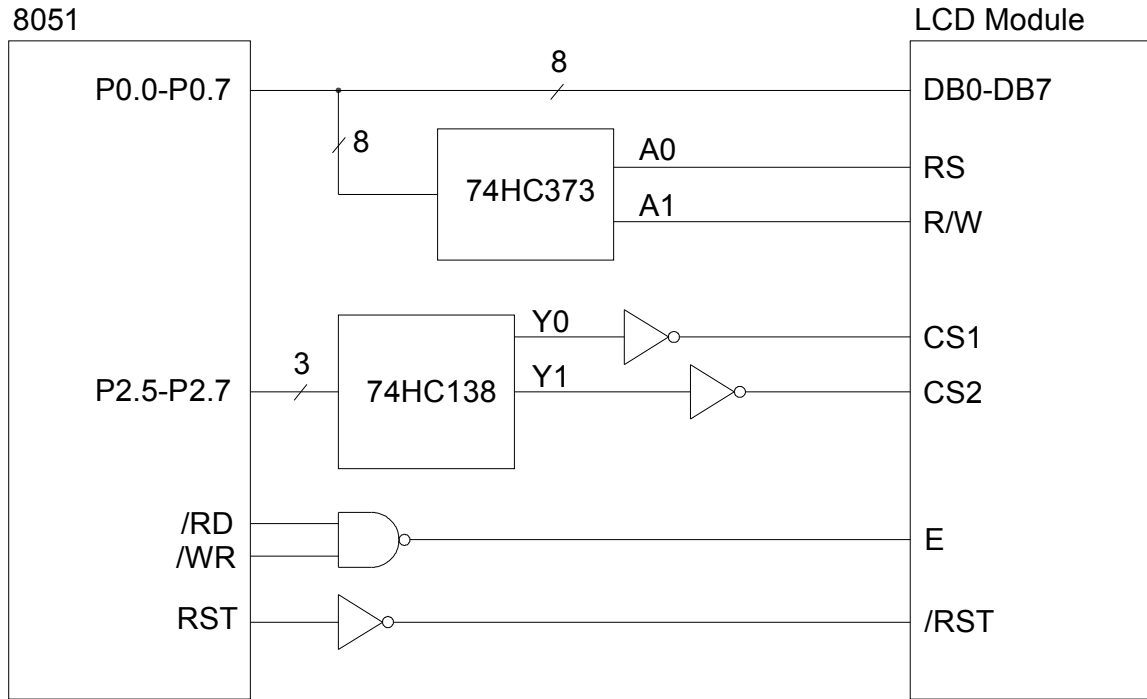
After reading instruction, Y address is increased by 1 automatically.

One time of dummy read must be required after column address setting.

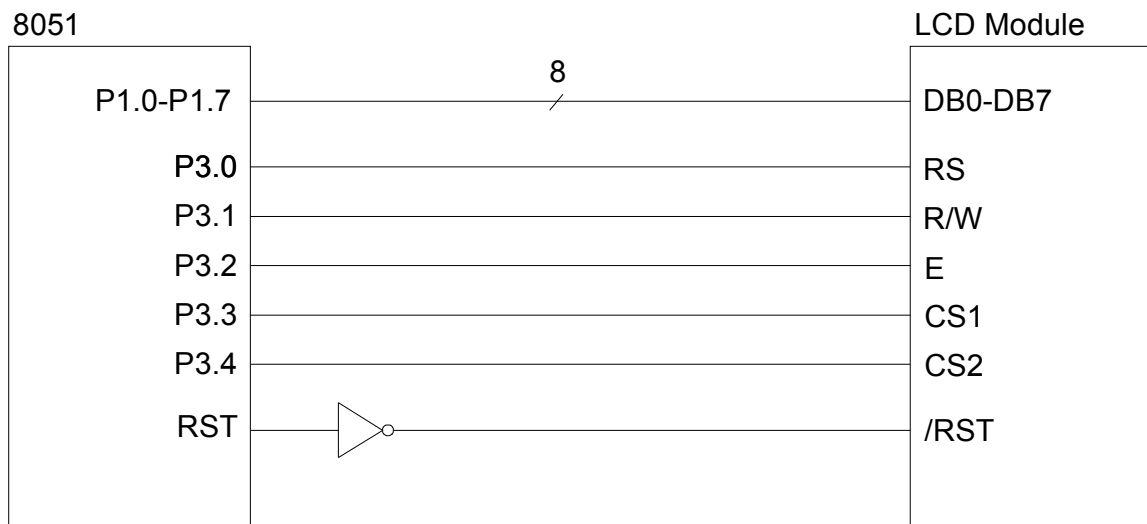
## 6. DISPLAY DATA RAM ADDRESS MAP

Page (X) Address	Display Data	1st S6B0108 (IC1) (CS1=H, CS2=L)								2nd S6B0108 (IC2) (CS1=L, CS2=H)								Line (Z) Address	Common		
0	D0															0	COM1				
	D1															1	COM2				
	D2															2	COM3				
	D3															3	COM4				
	D4															4	COM5				
	D5															5	COM6				
	D6															6	COM7				
	D7															7	COM8				
1	D0															8	COM9				
	D1															9	COM10				
	D2															10	COM11				
	D3															11	COM12				
	D4															12	COM13				
	D5															13	COM14				
	D6															14	COM15				
	D7															15	COM16				
2	D0															16	COM17				
	D1															17	COM18				
	D2															18	COM19				
	D3															19	COM20				
	D4															20	COM21				
	D5															21	COM22				
	D6															22	COM23				
	D7															23	COM24				
3	D0															24	COM25				
	D1															25	COM26				
	D2															26	COM27				
	D3															27	COM28				
	D4				LCD PANEL 128 X 64 DOTS												28	COM29			
	D5																			29	COM30
	D6																			30	COM31
	D7																			31	COM32
4	D0															32	COM33				
	D1															33	COM34				
	D2															34	COM35				
	D3															35	COM36				
	D4															36	COM37				
	D5															37	COM38				
	D6															38	COM39				
	D7															39	COM40				
5	D0															40	COM41				
	D1															41	COM42				
	D2															42	COM43				
	D3															43	COM44				
	D4															44	COM45				
	D5															45	COM46				
	D6															46	COM47				
	D7															47	COM48				
6	D0															48	COM49				
	D1															49	COM50				
	D2															50	COM51				
	D3															51	COM52				
	D4															52	COM53				
	D5															53	COM54				
	D6															54	COM55				
	D7															55	COM56				
7	D0															56	COM57				
	D1															57	COM58				
	D2															58	COM59				
	D3															59	COM60				
	D4															60	COM61				
	D5															61	COM62				
	D6															62	COM63				
	D7															63	COM64				
Column (Y) Address	0	1	2	-	61	62	63	0	1	2	-	61	62	63							
Segment	SEG1	SEG2	SEG3	-	SEG62	SEG63	SEG64	SEG65	SEG66	SEG67	-	SEG126	SEG127	SEG128							

## 7. CONNECTION WITH 8051 FAMILY MPU



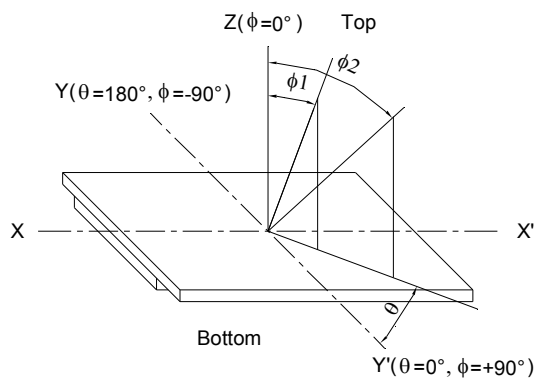
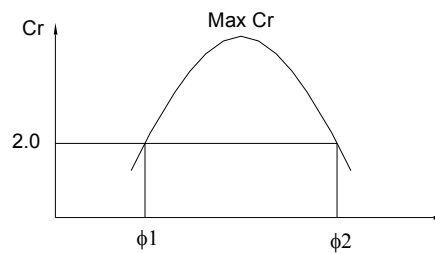
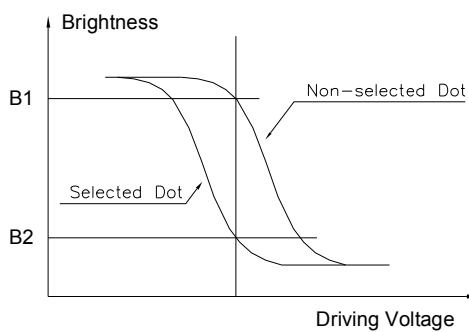
a. Application Circuit 1



b. Application Circuit 2

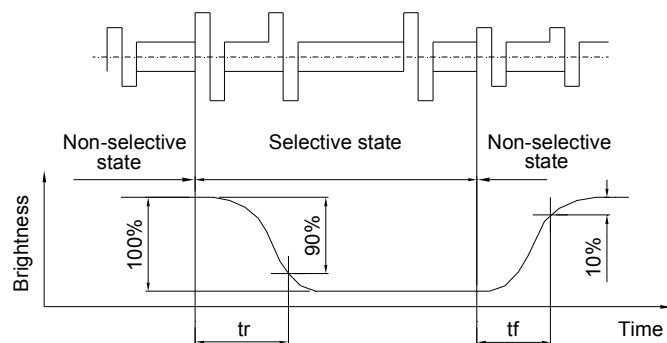
## 8. ELECTRO-OPTICAL CHARACTERISTICS ( $T_a=25^{\circ}\text{C}$ )

Item	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
View Angle	$\Phi 2-\Phi 1$	$Cr \geq 2$ , $\theta=0^{\circ}$	--	70	--	Deg	Note1, Note2
Contrast Ratio	Cr	$\Phi=0^{\circ}, \theta=0^{\circ}$	3	--	--	--	Note3
Response Time	tr (rise)	$\Phi=0^{\circ}, \theta=0^{\circ}$	--	200	--	ms	Note4
	tf (fall)	$\Phi=0^{\circ}, \theta=0^{\circ}$	--	250	--	ms	

Note1: Definition of viewing angle  $\phi$ ,  $\theta$ Note2: Definition of viewing angle range  $\phi 1$ ,  $\phi 2$ 

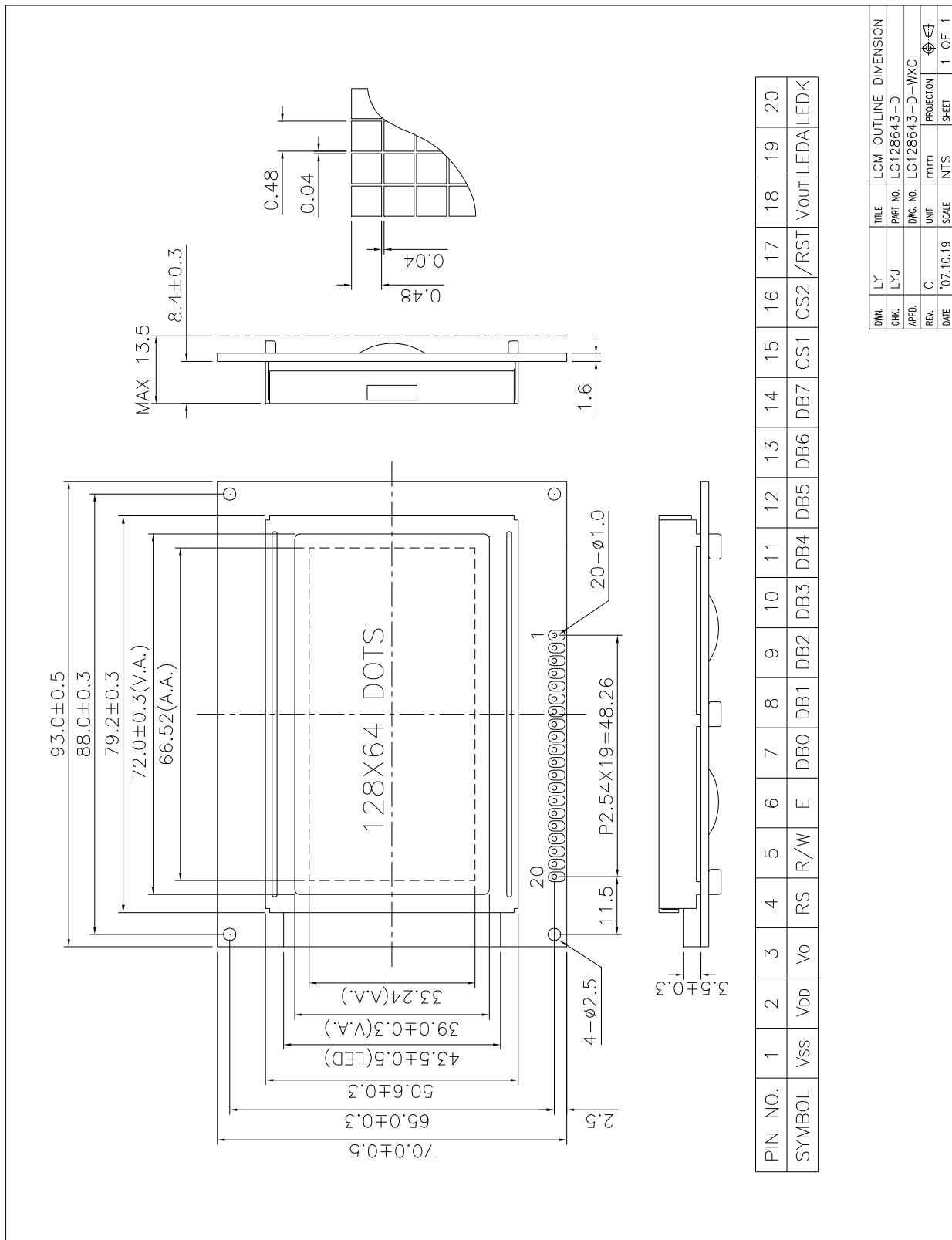
$$\text{Contrast Ratio} = \frac{\text{Brightness of non-selected dot (B1)}}{\text{Brightness of selected dot (B2)}}$$

Note3: Definition of contrast ratio (positive type)



Note3: Definition of response time

## 9. DIMENSIONAL OUTLINE





## 10. LCD MODULE NUMBERING SYSTEM

**L G 128 64 3 - B M D W H 6 V - XXXXX**  
 (1) (2) (3) (4) (5) (6) (7) (8) (9) (10) (11) (12) (13)

(1) Brand

(2) Module type

**C** - Character module

**G** - Graphic module

(3) Display format

Character module : Number of characters per line, two digits XX

Graphic module : Number of columns, three digits XXX

(4) Display format

Character module : Number of lines, one digit X

Graphic module : Number of rows, two or three digits XX or XXX

(5) Development number : One or two digits X or XX

(6) LCD mode

**T** - TN Positive, Gray

**N** - TN Negative, Blue

**S** - STN Positive, Yellow green

**G** - STN Positive, Gray

**B** - STN Negative, Blue

**F** - FSTN Positive, White

**K** - FSTN Negative, Black

**L** - FSTN Negative, Blue

**Q** - FFSTN Negative, Black

(7) Polarizer mode

**R** - Reflective

**F** - Transflective

**M** - Transmissive

(8) Backlight type

**N** - Without backlight

**L** - Array LED

**D** - Edge light LED

**E** - EL

**C** - CCFL

(9) Backlight color

**Y** - Yellow green

**B** - Blue

**W** - White

**G** - Green

**A** - Amber

**R** - Red

**M** - Multi color

**Nil** - Without backlight

(10) Operating temperature range

**S** - Standard temperature (0 to +50 °C)

**H** - Extended temperature (-20 to +70 °C)

(11) Viewing direction

**3** - 3:00

**6** - 6:00

**9** - 9:00

**U** - 12:00

(12) DC-DC Converter

**N or Nil** - Without DC-DC converter

**V** - Built in DC-DC converter

(13) Version code

**Nil or 0 to ZZZZZ** - Version code

## 11. PRECAUTIONS FOR USE OF LCD MODULE

### 11.1 Handling Precautions

- 1) The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 2) If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth. If the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 3) Do not apply excessive force on the surface of display or the adjoining areas of LCD module since this may cause the color tone to vary.
- 4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 5) If the display surface of LCD module becomes contaminated, blow on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents.
  - Isopropyl alcohol
  - Ethyl alcoholSolvents other than those mentioned above may damage the polarizer. Especially, do not use the following:
  - Water
  - Ketone
  - Aromatic Solvents
- 6) When mounting the LCD module make sure that it is free of twisting, warping, and distortion. Distortion has great influence upon display quality. Also keep the stiffness enough regarding the outer case.
- 7) Be sure to avoid any solvent such as flux for soldering never stick to Heat-Seal. Such solvent on Heat-Seal may cause connection problem of heat-Seal and TAB.
- 8) Do not forcibly pull or bend the TAB I/O terminals.
- 9) Do not attempt to disassemble or process the LCD module.
- 10) NC terminal should be open. Do not connect anything.
- 11) If the logic circuit power is off, do not apply the input signals.
- 12) To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - Be sure to ground the body when handling the LCD module.
  - Tools required for assembly, such as soldering irons, must be properly grounded.
  - To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
  - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

### 11.2 Storage Precautions

- 1) When storing the LCD module, avoid exposure to direct sunlight or to the light of fluorescent lamps and high temperature/high humidity. Whenever possible, the LCD module should be stored in the same conditions in which they were shipped from our company.

- 2) Exercise care to minimize corrosion of the electrodes. Corrosion of the electrodes is accelerated by water droplets or a current flow in a high humidity environment.

### 11.3 Design Precautions

- 1) The absolute maximum ratings represent the rated value beyond which LCD module can not exceed. When the LCD modules are used in excess of this rated value, their operating characteristics may be adversely affected.
- 2) To prevent the occurrence of erroneous operation caused by noise, attention must be paid to satisfy VIL, VIH specification values, including taking the precaution of using signal cables that are short.
- 3) The liquid crystal display exhibits temperature dependency characteristics. Since recognition of the display becomes difficult when the LCD is used outside its designated operating temperature range, be sure to use the LCD within this range. Also, keep in mind that the LCD driving voltage levels necessary for clear displays will vary according to temperature.
- 4) Sufficiently notice the mutual noise interference occurred by peripheral devices.
- 5) To cope with EMI, take measures basically on outputting side.
- 6) If DC is impressed on the liquid crystal display panel, display definition is rapidly deteriorated by the electrochemical reaction that occurs inside the liquid crystal display panel. To eliminate the opportunity of DC impressing, be sure to maintain the AC characteristics of the input signals sent to the LCD Module.

### 11.4 Others

- 1) Liquid crystals solidify under low temperatures (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the LCD module is subjected to a strong shock at a low temperature.
- 2) If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3) To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity, etc., exercise care to avoid touching the following sections when handling the module:
  - Terminal electrode sections.
  - Part of pattern wiring on TAB, etc.